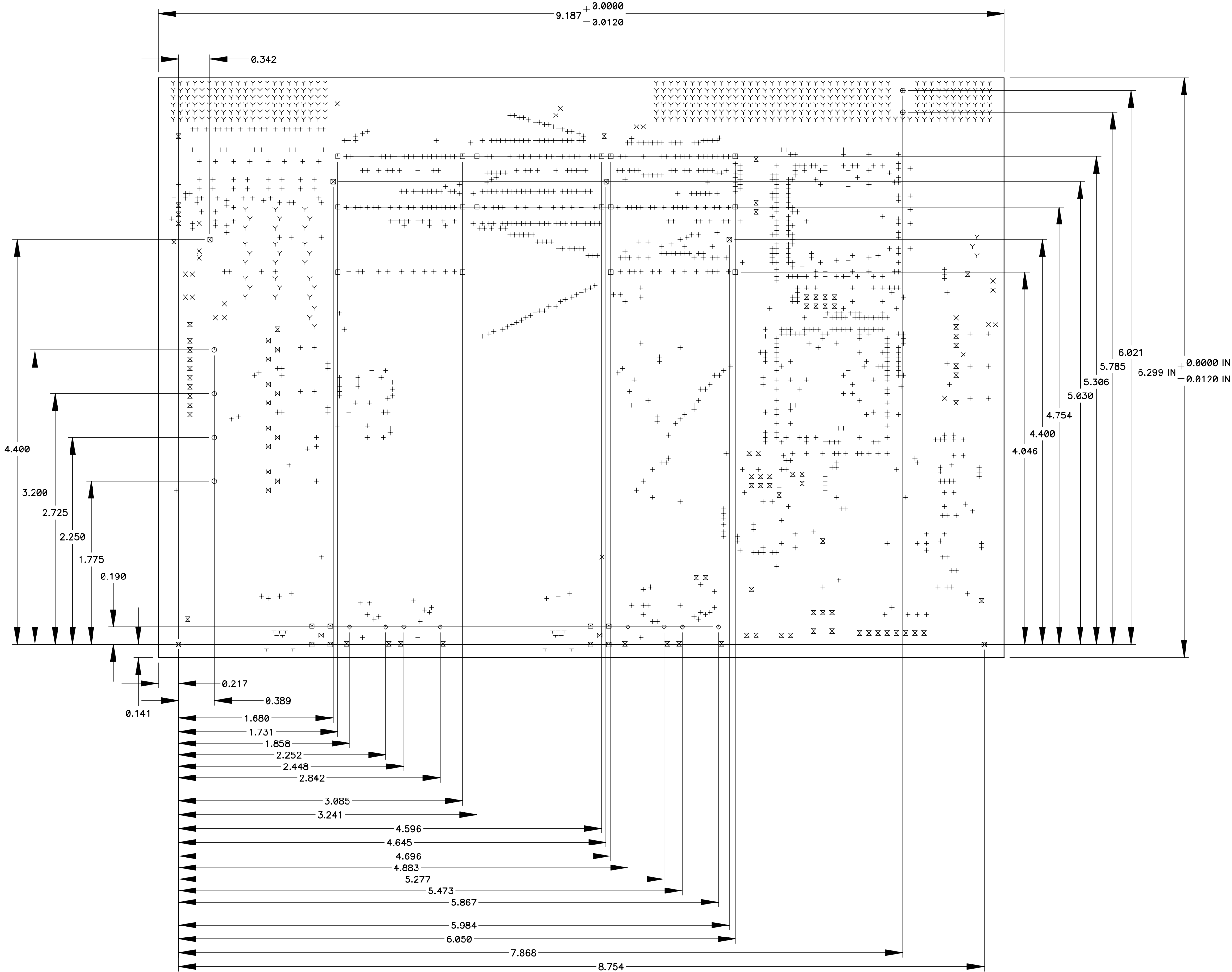


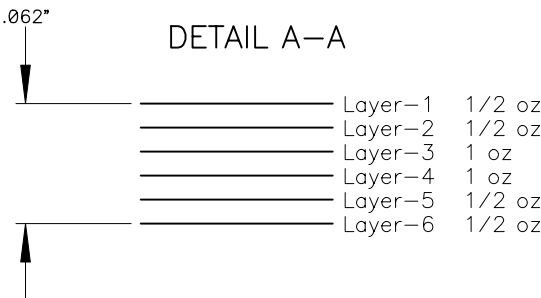
REVISIONS						
ZONE	LTR	REVISIONS			ECR	DATE
BY	APRV					



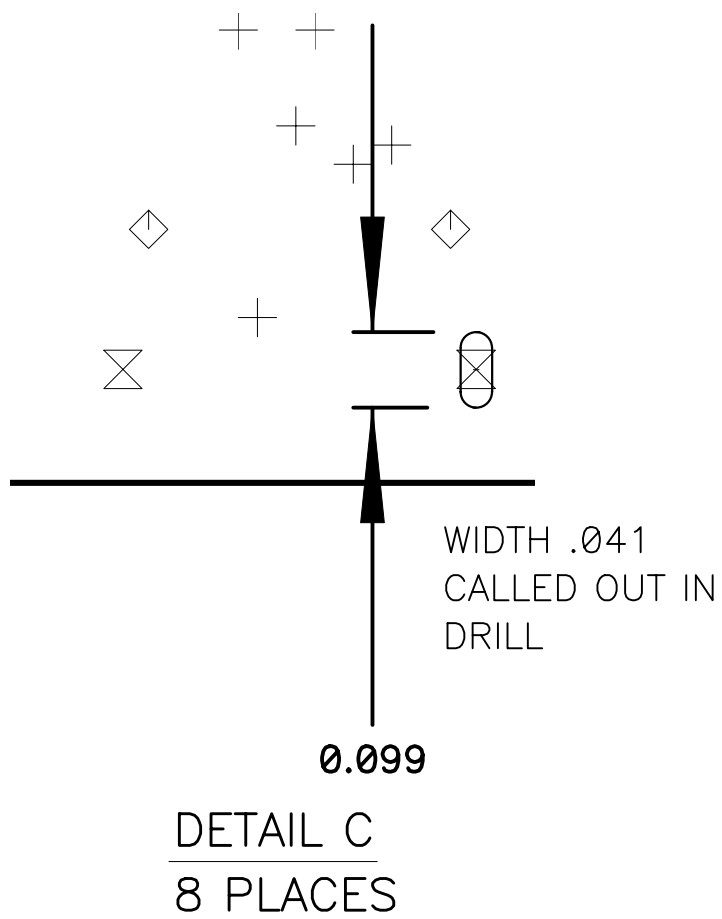
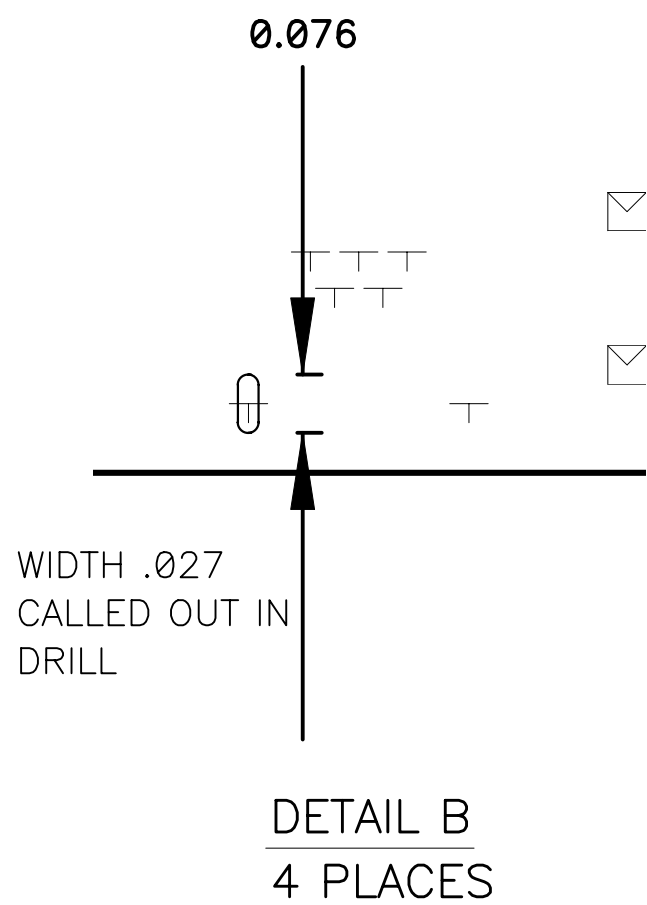
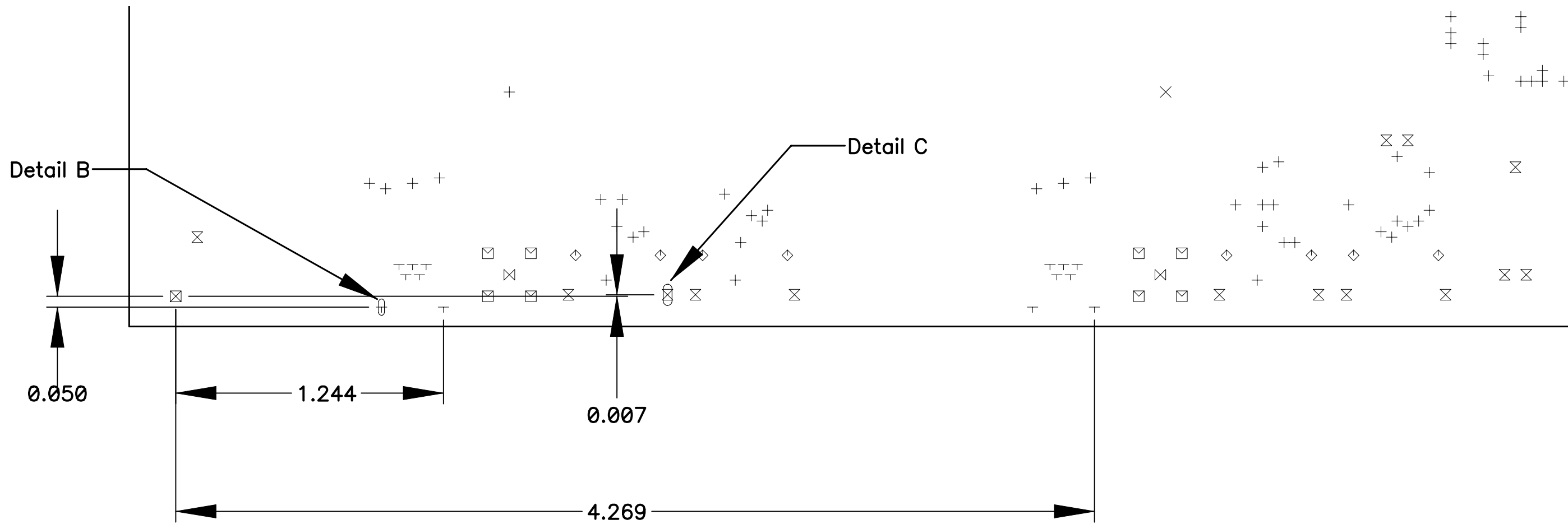
- NOTES: unless otherwise specified
- 1.0 Applicable documents  
The following items are required:  
PATTERN FILM DWG # MNSN-EL-04-3001  
DETAIL DRAWING DWG # MNSN-EL-04-1001 THIS DOCUMENT
  - 2.0 BASE MATERIAL  
2.1 Laminate base material shall be natural color, FR-4 or equivalent.  
See Detail A-A for layer to layer specification and overall thickness.  
2.2 B-Stage shall be selected at vendors discretion to meet over all board thickness and end item requirements.
  - 3.0 COPPER PLATING  
3.1 Copper plating shall have a minimum purity of 99.5 percent and a minimum thickness of .001 inch. This also applies to the plating in the holes.
  - 4.0 SOLDERMASK  
4.1 Apply LPI Green soldermask over bare copper according to the soldermask pattern file per IPC-SM-840.
  - 5.0 FINISH  
5.1 SMOBC, all exposed metal shall be coated in molten solder and hot air leveled, (HASL).
  - 6.0 SILK SCREEN  
6.1 Silk screen top (-1) and bottom (-6) side of board using yellow epoxy ink according to the -1ss pattern film and the -6ss pattern film.  
Ink shall not cover any exposed metal.
  - 7.0 DIMENSIONS  
7.1 All dimensions are in inches.  
7.2 Unless otherwise specified all hole sizes apply after plating.  
Hole sizes are shown in the drill schedule.
  - 8.0 TOLERANCES  
8.1 Hole size tolerance +-.003 after plating unless otherwise specified.  
8.2 Conductor widths and spacing shall be within 20% of the artwork originals.  
8.3 Layer to layer registration shall be .007 inches of true position  
8.4 Board dimensions shall meet the requirements of the board drawing.  
8.5 Warp and twist shall not exceed that defined in IPC-A-600.
  - 9.0 APPEARANCE  
9.1 All inside and outside corners shall have a maximum radius of .065  
9.2 Remove all burrs and smooth sharp edges to .010 max.

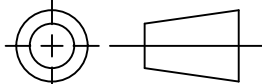
VENDOR NOTE: NOTIFY US OF ANY CONFLICTING REQUIREMENTS OR IF BOARDS CANNOT BE MANUFACTURED TO MEET THE ABOVE REQUIREMENTS, DUE TO VENDORS PROCESS AND/OR TECHNIQUES OR BECAUSE PHOTO TOOLS AND/OR SPECIFICATIONS ARE INADEQUATE.

Drill Table			
Hole Dia (inch)	Symbol	Quantity	Plated
0.013	+	1074	Yes
0.018	X	23	Yes
0.027	Y	432	Yes
0.027	-	14	Yes
0.041	X	78	Yes
0.047	M	14	Yes
0.055	□	16	No
0.063	◇	8	No
0.067	⊞	8	Yes
0.080	⊞	2	No
0.110	⊞	6	No
0.125	○	4	No



QTY REQ'D	PART OR IDENTIFYING NO	ITEM DESCRIPTION			ITEM NO
TOLERANCES UNLESS OTHERWISE NOTED .XX ± .03 .XXX ± .010		ANGULAR ± 5°		THIRD ANGLE PROJECTION	
DO NOT SCALE DRAWING		NAME		USED ON	REF
NEXT ASSEMBLY MNSN-EL-04-0001		DETAIL MONSOON MASTER CONTROL		MONSOON	
REFER TO SCHEMATIC MNSN-EL-04-2001				DWG SIZE C	REV --
SCALE: FULL	DESIGNED BY P.MOORE	DATE JAN04	CHECKED BY	DATE	DWG NO MNSN-EL-04-1001
DWG PRODUCED USING PCAD2001	DRAWN BY Dee Stover	DATE 12FEB04	APPROVED BY	DATE	RELEASED
			SHEET	1 OF 2	



QTY REQ'D		PART OR IDENTIFYING NO		ITEM DESCRIPTION			ITEM NO		
TOLERANCES UNLESS OTHERWISE NOTED  .XX ± .03 .XXX ± .010				 THIRD ANGLE PROJECTION		NATIONAL OPTICAL ASTRONOMY OBSERVATORIES OPERATED BY THE ASSOCIATION OF UNIVERSITIES FOR RESEARCH IN ASTRONOMY UNDER COOPERATIVE AGREEMENT WITH NATIONAL SCIENCE FOUNDATION			
DO NOT SCALE DRAWING		NAME				USED ON		REF	
NEXT ASSEMBLY MNSN-EL-04-0001		DETAIL MONSOON MASTER CONTROL				MONSOON			
REFER TO SCHEMATIC MNSN-EL-04-2001						DWG SIZE C		REV	
SCALE: FULL		DESIGNED BY P.MOORE		DATE JAN04		CHECKED BY		DATE	
						DWG NO		MNSN-EL-04-1001	
DWG PRODUCED USING PCAD2001		DRAWN BY Dee Stover		DATE 12FEB04		APPROVED BY		DATE	
						RELEASED		SHEET 2 OF 2	